MULTILAYER CERAMIC ANTENNA FOR BLUETOOTH/WLAN IEEE 802.11b & WLAN IEEE 802.11a (2.45/5.2GHz) (Surface Mounted Ceramic Dual Band Antenna)

Product Specification¹ (**Preliminary**)

8.7* 8 * 0.9 mm

QUICK REFERENCE DATA

Dimension

Central Frequency*

2.45 GHz /5.2GHz

Bandwidth

>100 MHz

Gain*

0 dBi max

VSWR 2.5 max
Polarization Linear

Azimuth Omni-directional

Impedance 50Ω

Operating Temperature -55~125 °C

Termination Ni/Sn (Environmentally-Friendly Leadless)

Resistance to soldering heat 260°C, 10 sec.

Maximum Power 1W

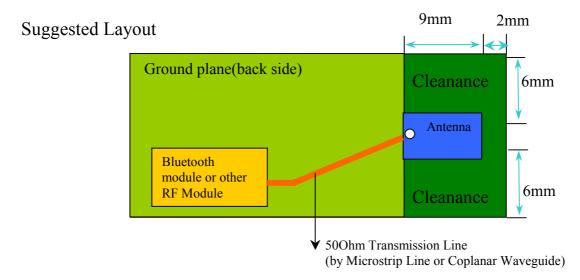
* Actual value will depend on size of customer ground plane

Special Environmental Concerns- Green Products Design: The foil making process is using environmentally-friendly aqueous solvent technology. Termination is lead free (Pb free) and packing materials can be re-cycled

¹ All the technical data and information contained herein are subject to change without prior notice

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APPLICATION



DIMENSIONAL DATA

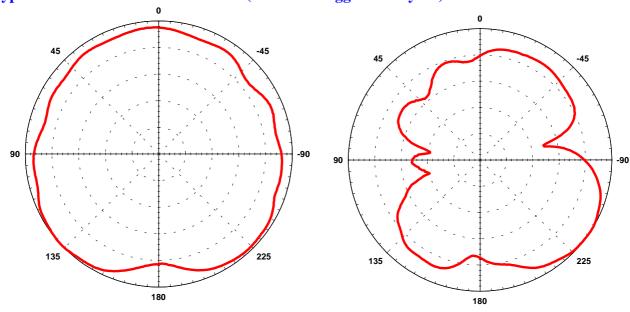
Figure	Dimension	Port
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	L 8.7 ±0.25 mm W 8 ±0.2 mm T 0.9 ±0.2 mm F 1.25 ±0.25 mm C 0.5 ±0.3 mm 1.25 ±0.35 mm	Feed Termination - NC Solder Termination

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SOLDER LAND PATTERN

Figure		Dimensions	Remark
L	L	10 ± 0.10 mm	
├	F	1.40 ± 0.10 mm	Feed Pad
	С	$0.90 \pm 0.10 \text{ mm}$	
	S1	1.40 ± 0.10 mm	NC Mount Pad
F_{\bullet} S_1			
\mathbf{C}			

Typical Radiation Pattern Polar Plot (Based on Suggested Layout)

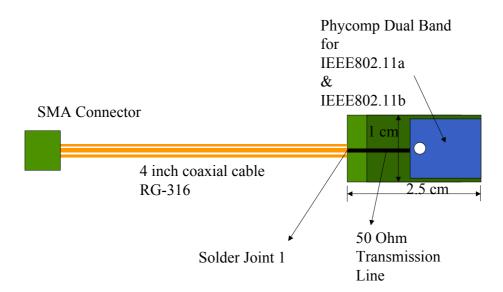


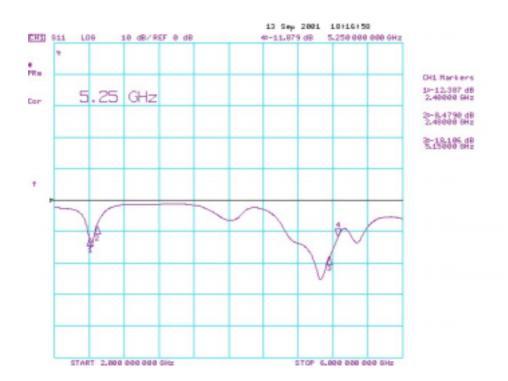
H-Plane

E-Plane

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CUSTOMERIZED TEST BOARD FOR RETURN LOSS





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RELIABILITY DATA (Reference to IEC Specification)

IEC 384-10/ CECC 32 100 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE REQUIREME				
4.4		Mounting	The antenna can be mounted on printed-circuit boards or ceramic substrates by applying wave soldering, reflow soldering (including vapour phase soldering) or conductive adhesive	No visible damage			
4.5		Visual inspection and dimension check	Any applicable method using × 10 magnification	In accordance with specification (chip off 4mm)			
4.6.1		Antenna	Frequency = 2.45/5.2 GHz; at 20 °C	Standard test board in page 4			
4.8		Adhesion	A force of 3 N applied for 10 s to the line joining the terminations and in a plane parallel to the substrate	No visible damage			
4.9		Bond strength of plating on end face	Mounted in accordance with CECC 32 100, paragraph 4.4	No visible damage			
			Conditions: bending 0.5 mm at a rate of 1mm/s, radius jig. 340 mm, 2mm warp on FR4 board of 90 mm length	No visible damage			

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IEC 384-10/ CECC 32 100 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
4.10	20(Tb)	Resistance to soldering heat	260 ± 5 °C for 10 ± 0.5 s in a static solder bath	The terminations shall be well tinned after recovery and Central Freq. Change ± 6%
		Resistance to leaching	260 ± 5 °C for 30 ± 1 s in a static solder bath	Using visual enlargement of × 10, dissolution of the termination shall not exceed 10%
4.11	20(Ta)	Solderability	Zero hour test, and test after storage (20 to 24 months) in original atmosphere; un-mounted chips completely immersed for 2 ± 0.5 s in 235 ± 5 °C.	The termination must be well tinned, at least 75% is well tinned at termination
4.12	4(Na)	Rapid change of temperature	-55 °C (30 minutes) to +125 °C (30 minutes); 100 cycles	No visible damage Central Freq. Change ± 6%
4.14	3(Ca)	Damp heat	500 ± 12 hours at 60 °C; 90 to 95 % RH	No visible damage 2 hours recovery Central Freq. Change ± 6%
4.15		Endurance	500 ± 12 hours at 125 °C;	No visible damage 2 hours recovery Central Freq. Change ± 6%

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ORDERING INFORMATION: Method I- by 12NC Ordering Code

The antennas may be ordered by using the 12 NC ordering code. These code numbers can be determined by the following rules:

 $\frac{43}{5}$ F C M S T A

F. Family Code

43 = Antenna

C. Packing Type Code

11 = 180 mm/ 7" blister (1000pcs)

M. Materials Code

1 = High Frequency Material

S. Size Code

17 = 8.7 * 8 * 0.9 mm

T. Tolerance

 $\mathbf{00} = 100 \text{ M}$ Hz Band Width

A. Working Frequency

252 = 2.45/5.2 GHz Dual Band

Example: 12NC 4311 117 00252

Product description: Antenna (43) by 180 mm blister (11) of High

Frequency Material (1), Size 8.7*8*0.9 mm (17);

Tolerance (00) of 100 MHz (VSWR<2.5)

Working Frequency (252) = 2.45/5.2G Hz Dual Band

ORDERING INFORMATION: Method II- by Clear Text Code

The antennas may be ordered by using the 16-digit clear text ordering code. These code numbers can be determined by the following rules:

	AN2520000708081K (Clear Text Code Example)										
AN	2520	00	07	0808	1	K					
Product	Central Freq.	Bandwidth	Material	Size	Quantities	Packing					
AN=	2520=2.45GHz	00 = > 100 MHz	07=K7	0808=8.7*8*	1 = 1K	K=7" plastic					
Antenna	+ 5.2GHz			0.9 mm	4 = 4K						

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